

Docket No.: P-0445A

PATENT



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

**Yong-Il KIM, Sung-Gue LEE,
and Yu-Seock YANG**

Serial No.: **10/743,302**

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Confirmation No.: **7847**

Group Art Unit: **2891**

Filed: **December 23, 2003**

Examiner: **David A. ZARNEKE**

Customer No.: **34610**

For: **METHOD FOR FABRICATING SEMICONDUCTOR PACKAGE AND
SEMICONDUCTOR PACKAGE**

AMENDMENT UNDER 37 C.F.R. § 1.312

U.S. Patent and Trademark Office
Customer Window, MAIL STOP AF
Randolph Building
401 Dulany Street
Alexandria, Virginia 22314

Sir:

Further to the Notice of Allowance dated **October 11, 2005**, please amend the above-identified application as follows:

Amendments to the Specification are reflected in this paper.

Remarks/Arguments begin after the listing of the claims.

*DK
letter
10/23/06*